

02-02-2000

Docket No.: SEC.677

SHEET

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office



101257365

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

SUNG, Woo-dong
HAN, Sam-soon
OH, Chang-wook
NAM, Jeong-lim

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: Jan. 8, 2000

2. Name and address of receiving party(ies):

Name: Samsung Electronics Co., Ltd.

Address: 416, Maetan-dong, Paldal-gu,

City: Suwon-city, Kyungki-do State/Prov.: _____

Country: Republic of Korea ZIP: _____

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is: Jan. 8, 2000

Patent Application No.

Filing date

01/31/2000 NGORDON 00000023 09482537
NEW JAN. 14, 2000
02 FC:581 40.00 OP

B. Patent No.(s)

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: RAYMOND C. JONES

Registration No. 34,631

Address: JONES VOLENTINE, LLP

12200 SUNRISE VALLEY DRIVE, SUITE 150

City: RESTON State/Prov.: VA

Country: U.S.A. ZIP: 20191

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

☒ Enclosed - Any excess or insufficiency should be credited or debited to deposit account

☐ Authorized to be charged to deposit account

8. Deposit account number:

50-0238

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

RAYMOND C. JONES

Name of Person Signing

Signature

JAN. 14, 2000

Date

Total number of pages including cover sheet, attachments, and

3

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert Name(s)
of Inventor(s)

SUNG, Woo-dong

HAN, Sam-soon

OH, Chang-wook

and

NAM, Jeong-lim

Insert Name(s)
of Assignee(s)

the undersigned hereby sell(s) and assign(s) to

SAMSUNG ELECTRONICS CO., LTD.

Address

of 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

Title of
Invention

SYSTEM FOR PROCESSING SEMICONDUCTOR WAFERS PRODUCING A DOWNWARD LAMINAR FLOW OF CLEAN AIR IN FRONT OF BAKING UNITS

for which an application for patent in the United States of America has been executed by the undersigned

Date of Signing
of Application

on January 8, 2000

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) to Raymond C. Jones, Reg. No. 34,631 and Adam C. Volentine, Reg. No. 33,289, members of the firm of JONES VOLENTINE, L.L.P. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 8 Jan 2000, Name of Inventor Woo-dong Sung
Date 8 Jan 2000, Name of Inventor Sam-soon Han
Date 8 Jan 2000, Name of Inventor Chang-wook Oh
Date 8 Jan 2000, Name of Inventor Jeong-lim Nam
Date _____, Name of Inventor _____

(Note regarding Witnessing and/or Acknowledgment: Acknowledgment before a United States Consul is preferred but not required. If not acknowledged, then it is recommended that the execution by the Inventor(s) be witnessed by at least two witnesses who sign here. However, the current practice of the U.S. Patent and Trademark Office is to record an Assignment even if it has not been acknowledged and/or witnessed.)

Witness _____

Witness _____

ACKNOWLEDGMENT

} ss

This _____ day of _____, 19____, before me personally came the above-named _____

to me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

Official Signature

SEAL

Official Title

Applicant Reference No.: SS-13584-US Atty Docket No.: SEC.677

Serial No.: _____ Filing Date: _____